UTC UNISONIC TECHNOLOGIES CO., LTD

6N60 Power MOSFET

6.2A, 600V N-CHANNEL POWER MOSFET

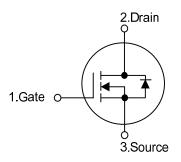
DESCRIPTION

The UTC 6N60 is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in switching power supplies and adaptors.

FEATURES

- * $R_{DS(ON)}$ < 1.5 Ω @ V_{GS} = 10V
- * Ultra low gate charge (typical 20 nC)
- * Low reverse transfer Capacitance (C_{RSS} = typical 10pF)
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

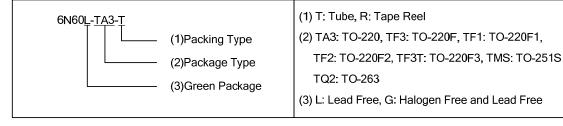
SYMBOL

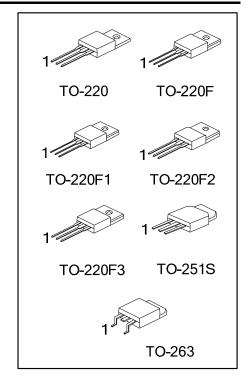


ORDERING INFORMATION

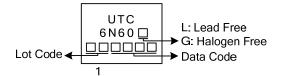
Ordering Number		Dookaga	Pin Assignment			Packing	
Lead Free	Halogen Free	Package 1		2	3	Packing	
6N60L-TA3-T	6N60G-TA3-T	TO-220	G	D	S	Tube	
6N60L-TF3-T	6N60G-TF3-T	TO-220F	G	D	S	Tube	
6N60L-TF1-T	6N60G-TF1-T	TO-220F1	G	D	S	Tube	
6N60L-TF2-T	6N60G-TF2-T	TO-220F2	G	D	S	Tube	
6N60L-TF3T-T	6N60G-TF3T-T	TO-220F3	G	D	S	Tube	
6N60L-TMS-T	6N60G-TMS-T	TO-251S	G	D	S	Tube	
6N60L-TQ2-T	6N60G-TQ2-T	TO-263	G	D	S	Tube	
6N60L-TQ2-R	6N60G-TQ2-R	TO-263	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source





■ MARKING



■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	600	V
Gate-Source Voltage		V_{GSS}	±30	V
Avalanche Current (Note 2)		I _{AR}	6.2	Α
Continuous Drain Current		I _D	6.2	Α
Pulsed Drain Current (Note 2)		I _{DM}	24.8	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS} 440		mJ
	Repetitive (Note 2)	E _{AR}	13	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	ns
Power Dissipation	TO-220/TO-263		125	W
	TO-220F/TO-220F1 TO-220F3	P_{D}	40	W
	TO-220F2		42	W
	TO-251S		55	W
Junction Temperature		TJ	+150	°C
Operating Temperature		T _{OPR}	-55 ~ +150	°C
Storage Temperature		T _{STG}	-55 ~ + 150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating : Pulse width limited by T_{J}
- 3. L = 25mH, I_{AS} = 6A, V_{DD} = 90V, R_G = 25 Ω , Starting T_J = 25°C
- 4. $I_{SD} \le 6.2 A$, di/dt $\le 200 A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT	
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2 TO-220F3/TO-263	θ_{JA}	62.5	°C/W	
	TO-251S		110		
Junction to Case	TO-220/TO-263	$ heta_{ extsf{JC}}$	1.0		
	TO-220F/TO-220F1 TO-220F3		3.2	°C/W	
	TO-220F2		2.97		
	TO-251S		2.27		

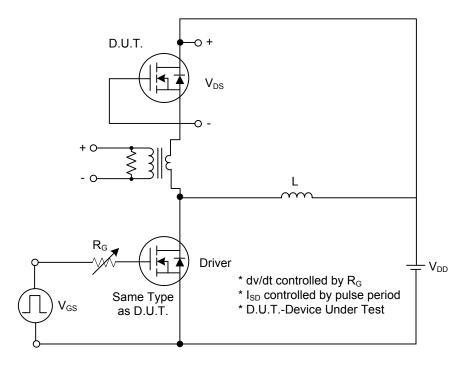
■ ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250μA	600			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =600V, V _{GS} =0V			10	μΑ
			V _{DS} =480V, V _{GS} =0V, T _J =125°C			10	μΑ
Gate- Source Leakage Current	Forward	1000	V _G =30V, V _{DS} =0V			100	nA
	Reverse		V _{GS} =-30V, V _{DS} =0V			-100	nA
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS}/\triangle T_J$	I _D =250μA, Referenced to 25°C		0.53		V/°C
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$			4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =3.1A		1.0	1.5	Ω
DYNAMIC CHARACTERISTICS							
nput Capacitance		C_{ISS}			770	1000	pF
Output Capacitance		Coss	V _{DS} =25V, V _{GS} =0V, f=1.0 MHz		95	120	pF
Reverse Transfer Capacitance		C_{RSS}			10	13	pF
SWITCHING CHARACTERISTICS	3						
Turn-On Delay Time		t _{D(ON)}]		40	50	ns
Turn-On Rise Time		t _R	V_{DD} =300V, I_{D} =6.2A, R_{G} =25 Ω		70	150	ns
Turn-Off Delay Time		t _{D(OFF)}	(Note 1, 2)		40	90	ns
Turn-Off Fall Time		t _F			80	100	ns
Total Gate Charge		Q_G	V _{DS} =480V, I _D =6.2A, V _{GS} =10V		20	25	nC
Gate-Source Charge		Q_GS	(Note 1, 2)		4.9		nC
Gate-Drain Charge		Q_GD	,		9.4		nC
DRAIN-SOURCE DIODE CHARA	CTERISTIC	CS AND MAXI	MUM RATINGS			1	
Drain-Source Diode Forward Voltage		V_{SD}	V _{GS} =0V, I _S =6.2 A			1.4	V
Maximum Continuous Drain-Source Diode		Is				6.2	Α
Forward Current						0.2	
Maximum Pulsed Drain-Source Diode		I _{SM}				24.8	Α
Forward Current		-					
Reverse Recovery Time		t _{rr}	_V _{GS} =0V, I _S =6.2A, dI _F /dt =100 A/μs (Note 1)		290		ns
Reverse Recovery Charge		Q_{RR}			2.35		μC

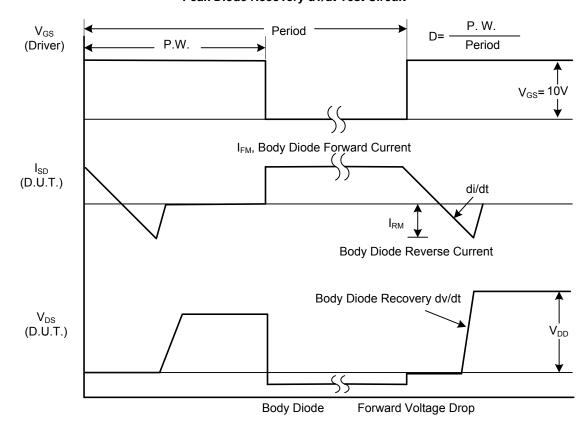
Notes: 1. Pulse Test: Pulse width \leq 300 μ s, Duty cycle \leq 2%.

^{2.} Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

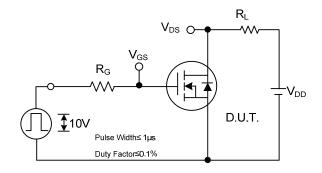


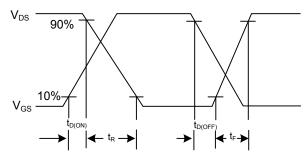
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

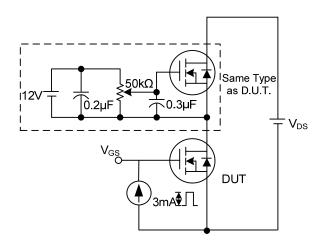
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

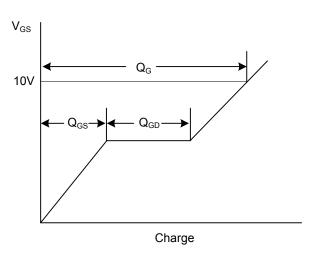




Switching Test Circuit

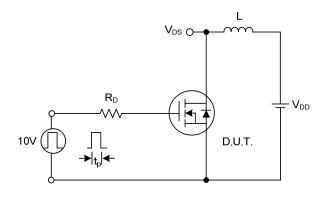
Switching Waveforms

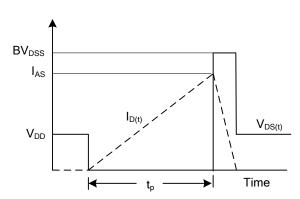




Gate Charge Test Circuit

Gate Charge Waveform

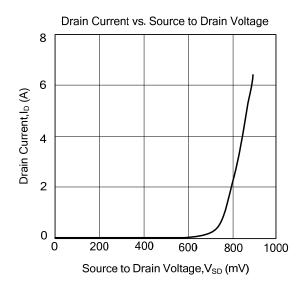


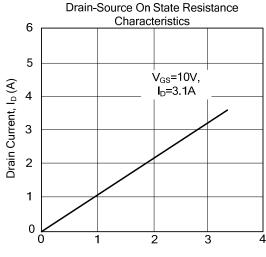


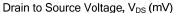
Unclamped Inductive Switching Test Circuit

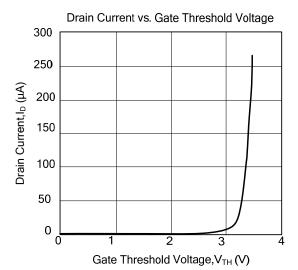
Unclamped Inductive Switching Waveforms

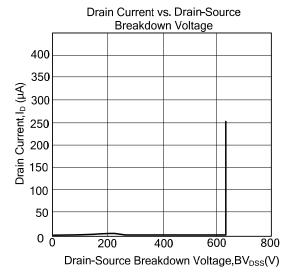
■ TYPICAL CHARACTERISTICS











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